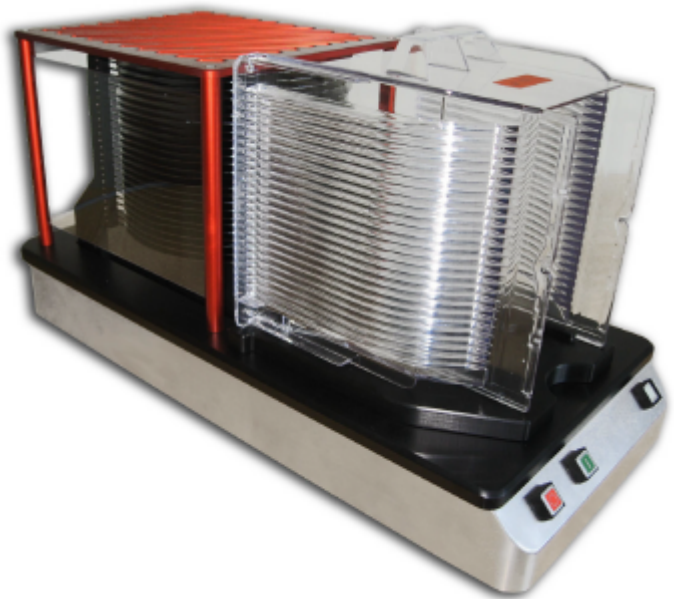


Wafer Mover Low Contact System (WMLC)

The Wafer mover Low Contact system **WMLC** is high-quality equipment for unloading and loading of wafer. In a work procedure all wafer automatically and without further manual contact with the help of ptfе-coated needles are reloaded into the empty carrier at the same time. In particular reloading between **high and lowprofile carrier** is possible.

The equipment is simple in application, long-lived and maintenance-free. Excluding high-quality materials are used with the production of the **WMLC**. They are the basis for a long life span and ensure the working reliability with each processing step. The **WMLC** is suitable thereby ideally for the use in the cleanroom.

Depending upon execution the equipment is available for reloading 6" or 8" wafer. It is compatible with the usual high and low profile carrier type with "H"-ground structure. Please indicate the carrier designations for your order.



Electrical connection data

Supply voltage	110 – 240 V
Capacity maximally	80 VA
Frequency	50/60 Hz
Safety class system	I
Connecting cable	3 x 1mm ² >= 2,5m long
Connection	Cold device plug 3-pin

Generally

	WMLC 6"	WMLC 8"
Width	265 mm	265 mm
Height	245 mm	285 mm
Depth	545 mm	545 mm
Weight	about 18,5 kg	About 19 kg

Order remarks

33xxx	WMLC 6" Wafer Mover Low Profil System
32947	WMLC 8" Wafer Mover Low Profil System